SI	PE	CI	FI	$C\Delta$	TI		21
J	'	CI.				VI.	40

CUSTOMER . CDE012

SAMPLE CODE . SH800480T024-IHB

MASS PRODUCTION CODE . PH800480T024-IHB

SAMPLE VERSION . 01

SPECIFICATIONS EDITION . 003

DRAWING NO. (Ver.) . LMD-PH800480T024-IHB(Ver.002)

PACKAGING NO. (Ver.) PKG-PH800480T024-IHB(Ver.001)

## **Customer Approved**

Date:

Approved	Checked	Designer		
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2016.11.29

- Preliminary specification for design input
- Specification for sample approval

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# **History of Version**

Date (mm / dd / yyyy)	Ver.	Edi.	Description	Page	Design by
09/07/2016	01	001	New Drawing.	-	Howard
11/02/2016	01	002	New Sample  Modify Component height	- Appendix	Howard
11/25/2016	01	003	Add 1.7.5 Touch Panel Design/Handing Guide	12,13	Howard
				$\rightarrow$	
		V			

Total: 31 Pages



### **Contents**

### 1. SPECIFICATIONS

- 1.1 Features
- 1.2 Mechanical Specifications
- 1.3 Absolute Maximum Ratings
- 1.4 DC Electrical Characteristics
- 1.5 Optical Characteristics
- 1.6 Backlight Characteristics
- 1.7 Touch Panel Specification

## 2. MODULE STRUCTURE

- 2.1 Counter Drawing
- 2.2 Interface Pin Description
- 2.3 Timing Characteristics

#### 3. QUALITY ASSURANCE SYSTEM

- 3.1 Quality Assurance Flow Chart
- 3.2 Inspection Specification

#### 4. RELIABILITY TEST

**Reliability Test Condition** 

## 5. PRECAUTION RELATING PRODUCT HANDLING

- 5.1 Safety
- 5.2 Handling
- 5.3 Storage
- **Terms of Warranty** 5.4

Appendix: 1.LCM Drawing

2. Packing Specification

Note: For detailed information please refer to IC data sheet: Primacy(TFT LCD): ILITEK: ILI6122M-9G / ILI5960-9G



## 1. SPECIFICATIONS

## 1.1 Features

Item	Standard Value
item	Staridard value
Display Resolution	800 * 3 (RGB) * 480 Dots
LCD Type	a-Si TFT , Normally white, Transmissive type
Screen size(inch)	5.0 inch
Viewing Direction	6 O'clock
Surface treatment	Anti-Glare
Color configuration	RGB Vertical Strip
Backlight Type	White LED B/L
Weight	80g
Interface	24 Bits RGB interface
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer website:
	http://www.powertip.com.tw/news.php?area_id_view=1085560481/

# 1.2 Mechanical Specifications

ltem	Standard Value	Unit
Outline Dimension	121.0(W) x 75.9 (L) x 4.2(H)	mm

## LCD panel

Item	Standard Value	Unit
Viewing Area	109.0 (W) * 65.8 (L)	mm
Active Area	108.0 (W) x 64.8 (L)	mm

## Touch panel

Item	Standard Value	Unit
Viewing Area	110.4 (W) * 67.4 (L)	mm
Active Area	109.0 (W) * 65.8 (L)	mm

Note: For detailed information please refer to LCM drawing



## 1.3 Absolute Maximum Ratings

#### Module

Item	Symbol	Condition	Min.	Max.	Unit	Remark
Power Supply for TFT Panel	VDD	GND=0	-0.3	4.5	V	
Power Supply for Backlight Unit	VCC	GND=0	-0.3	+20.0	V	-
Operating Temperature	Top	-	-20	70	∞	
Storage Temperature	T <sub>ST</sub>	-	-30	80	∞	

The absolute maximum rating values of this product are not allowed to be exceeded at any times. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.

## 1.4 DC Electrical Characteristics

**Module** GND = 0V, Ta = 25  $^{\circ}$ C

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Power Supply for TFT Panel	VDD	GND=0V	3.0	3.3	3.6	V
Power Supply for Backlight Unit	VCC	GND=0V	5	12	15	V
Input Voltage for	VIH	GND=0V	0.7VDD	-	VDD	
TFT Panel	VIL	GND=0V	0	-	0.3VDD	V
Supply Current for TFT Panel	IDD	IDD@VDD=3.3V	-	120	180	
Supply Current for Backlight Unit	ICC	ICC@VCC=5V	-	400	600	mA
Supply Current for Backlight Unit	ICC	ICC@VCC=12V	-	150	250	
Input Voltage for	VPH	GND=0V	1.2	-	-	V
PWM Signal	VPL	GND=0V	-	-	0.4	V
Dimming Clock Rate	fP	GND=0V	5	-	100	KHz



# 1.5 Optical Characteristics

## **TFT LCD Module**

VDD= 3.3 V, Ta=25 ℃

Item		Symbol	Condition	Min.	Тур.	Max.	unit	-
Response time	Response time Tr+Tf		-	_	24	36	ms	-
Trooperior time	Тор	25℃ θY+			60	-		
	Bottom	θY-			60	-		
Viewing angle	Left	θХ-	CR ≥ 10		60	-	Deg.	Note 4
	Right	θX+			60	-		
Contrast rati	0	CR		500	600	-	-	Note 3
	White	Х		0.26	0.31	0.36	-/-	Note1
	vvriite	Υ	Ta = 25 ℃ θX , θY = 0°	0.29	0.34	0.39		
Color of CIE	Red	X		0.51	0.56	0.62		
Coordinate		Y		0.28	0.33	0.38		
(With B/L & T/P)	Green	X		0.29	0.34	0.39		
(Willi B/E & 1/1 )		Υ		0.55	0.60	0.65		
		Х		0.09	0.14	0.19		
		Υ		0.04	0.09	0.14		
Average Brightr	ness		VCC=5.0V					
Pattern=white di	Pattern=white display		PWM="High"	620	780	-	cd/m2	Note1
(With LCD & T/P)*1			(Duty=100%)					
Uniformity			VCC=5.0V					
(With LCD & T/	P)*2	∆B	PWM="High"	70	-	-	%	Note1
( 202 a 17)	, –		(Duty=100%)					



#### Note 1:

\*1 : △B=B(min) / B(max) \* 100%

\*2 : Measurement Condition for Optical Characteristics:

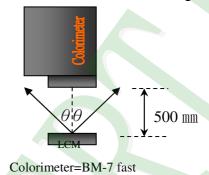
a : Environment: 25°C±5°C / 60±20%R.H, no wind, dark room below 10 Lux at typical lamp current and typical operating frequency.

b : Measurement Distance:  $500 \pm 50$  mm  $, (\theta = 0)$ 

c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation.

d: The uncertainty of the C.I.E coordinate measurement ±0.01, Average Brightness ± 4%





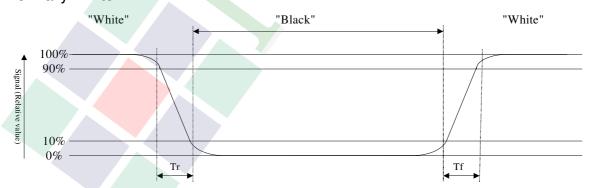
To be measured at the center area of panel with a viewing cone of 1° by Topcon luminance meter BM-7, after 10 minutes operation (module)

#### Note2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.

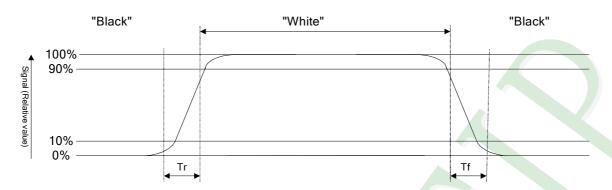
#### Refer to figure as below:

#### Normally White





## Normally Black



Note3: Definition of contrast ratio:

Contrast ratio is calculated with the following formula

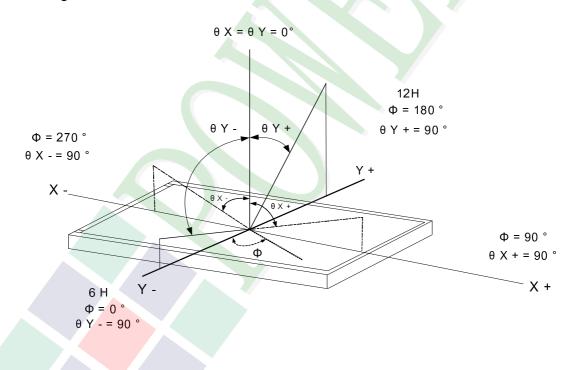
Photo detector output when LCD is at "White" state

Contrast ratio (CR) =

Photo detector output when LCD is at "Black" state

## Note4: Definition of viewing angle:

Refer to figure as below:





## 1.6 Backlight Characteristics

Maximum Ratings

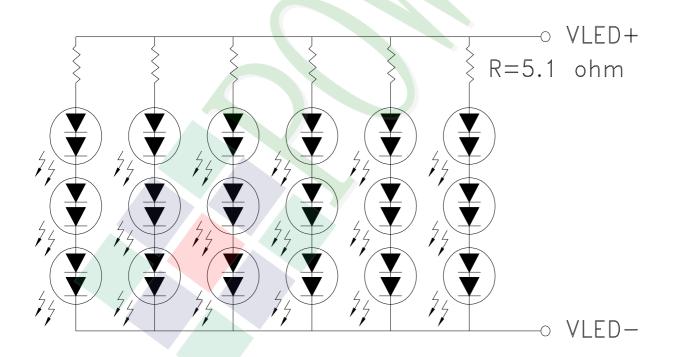
Item	Symbol	Min.	Max.	Unit	Remark
LED Forward Current	lF	2-	10	mA	0.55   FD
LED Reverse Voltage V <sub>R</sub> 5		5	٧	One LED	

**Electrical / Optical Characteristics** 

Item	Symbol	Min.	Тур.	Max.	Unit	Remark
LED Voltage	VL	16.2	18.0	19.2	V	Note1
LED Current	lι	-	90	-	mA	<u>-</u>
LED life time	-	50,000	-	-	Hr	Note2

Note 1: The LED Supply Voltage is defined by the number of LED at Ta=25 °C and I∟=90 mA.

Note 2: The "LED life time" is defined as the module brightness decrease to 50% original brightness at Ta=25  $^{\circ}$ C and IL =90 mA. The LED life time could be decreased if operating IL is larger than 90 mA.





## 1.7 Touch Panel Specification

## 1.7.1 Optical Characteristics

Item	Specification
1.Transparency	78% Min

#### 1.7.2 Mechanical Characteristic

Item	Specification
1.Input Method	Finger or stylus pen
2.Hardness of surface	3H -pressure 500g of ,45deg.
3.Activation Force	120gf less individual point with stylus pen(R0.8)
	Activation force guarantee area:3.0mm inside of Active Area.
4.Linearity Force	120gf less input with stylus pen(R0.8)
	Activation force guarantee area:3.0mm inside of Active Area.

#### 1.7.3 Electrical Characteristics

Item	Specification
1.Rated Voltage	DC 5V(DC 7V Max)
2.Resistance Between	Direction X (Film side): (200Ω)~ (1050Ω)
Terminals.	Direction Y (Glass side): (100Ω)~ (900Ω)
3.Insulation Resistance	20 M $\Omega$ or more (DC 25 V 1min)
4.Linearity	±1.5%. Linearity(%)= ΔV/ (EV-SV) *100. ΔV: The difference between the ideal voltage and measured voltage on the each measuring line. SV: Voltage of starting Points. EV: Voltage of Ending Points. (Test condition refers to 1.7.2 item4)
5.Bouncing	<10ms (Tip R 3.75mm, hardness 10°~20°, silicon rubber ,500gf operation : 40 mm/sec )



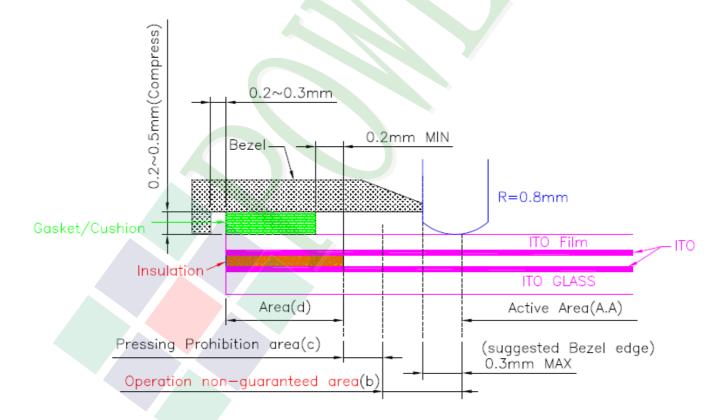
## 1.7.4 Reliability Characteristic

NO	Test Item	Test Condition	Test Result
	Hitting Durability	1,000,000times min.(R 8 mm	Follow 1.7.3 item2 and
1		Silicon Rubber Hardness	item4.
		60°250gf 3times/sec).	
2	Pen Sliding Durability	100,000 times min	Follow 1.7.3 item2 and
		(TipR0.8mm).	item4.
		ψ9mm steel ball is dropped on	No Crack
3	Impact Resistance	the surface from 30 cm height	
		at 1 time.	
4	Flexible pattern Bending	Bending 3 times by bending	Follow 1.7.3 item2.
4	Resistance	radius R1.0 mm	



### 1.7.5 Touch Panel Design/Handing Guide

- (1) Keep the gap, for example 0.2 to 0.3mm, between bezel edge and T/P edge. The reason is to avoid the bezel edge from contacting T/P surface that may cause "short" with bottom layer
- (2) Insertion a cushion material is recommended.
- (3) The cushion material should be limited on the busbar insulation paste area. If it is over the transparent insulation paste area, a "short" may be occurred.
- (4) Do not to use an adhesive tape to bond it on the front of T/P and hang it to the housing bezel.
- (5) Never expand the T/P top layer (PET Film) like a balloon by internal air pressure. The life of the T/P will extremely decreasing.
- (6) Top layer, PET, dimension is changing base on environment temperature and humidity. Please avoid a stress from housing bezel to top layer, because it may cause "waving".
- (7) The input to the Touch Panel sometimes distorts touch panel itself.
- (8)To use the stylus pen or fingernail sliding at the edge of the housing is prohibited. It would cause the cracking of the ITO coating and damage the touch panel. It also request not to press this area while assembling
- (9) Purpose: In order to prevent accidental use and performance deterioration, please keep the following precautions.



In order to prevent unusual performance degradation and malfunction of a touch panel, please carry out the set case designing and a touch panel assembling method after surely considering the definition of each area illustrated in above figure.



### Area(a): Active area

The active area is guaranteed the position data detectable precision, operation force and other operations. it is strongly recommended to place the operation button or menu keys within the active area. Due to structure, the active area is less durable at the edge or close to the edge.

#### Area(b): Operation non-guaranteed area

This area does not guarantee a touch panel operation and its function. When this area is pressed, touch panel shows degradation of its performance and durability such as a pen sliding durability becomes about one-tenth compared with the active area (area-(a) as guaranteed area) and its operation force requires about double. About 0.5 mm outside from a boundary of the active area corresponds to this area.

#### Area(c): Pressing prohibition area

The area which forbids pressing, because an excessive load is applied to a transparent electrode (ITO) and a serious damage is given to a touch panel function by pressing. About 0.5 mm outside from Operation non-guaranteed area.

Area(d): Non-Active area

The area does not activate even if pressed.





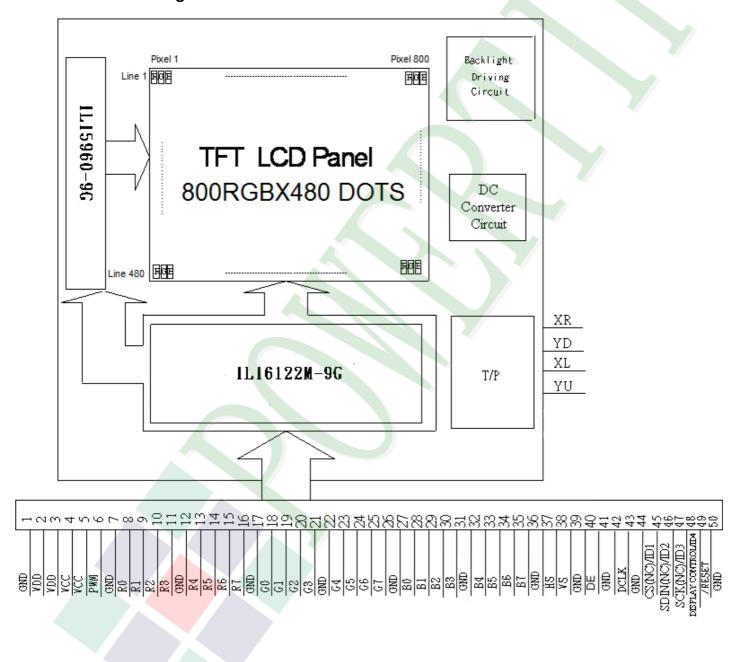
## 2. MODULE STRUCTURE

## 2.1 Counter Drawing

### 2.1.1 LCM Mechanical Diagram

\* See Appendix

#### 2.1.2 Block Diagram





# 2.2 Interface Pin Description

Pin#	Name	DESCRIPTION
1	GND	Power ground.
2	VDD	Power for Digital Circuit.
3	VDD	Power for Digital Circuit.
4	VCC	Power For LED backlight.
5	VCC	Power For LED backlight.
6	PWM	Shutdown & Dimming control input for backlight. Do not allow this pin to float. "Hi" =100%, "Low" = 0%.
7	GND	Power ground.
8	R0	Red Data.
9	R1	Red Data.
10	R2	Red Data.
11	R3	Red Data.
12	GND	Power ground.
13	R4	Red Data.
14	R5	Red Data.
15	R6	Red Data.
16	R7	Red Data.
17	GND	Power ground.
18	G0	Green Data.
19	G1	Green Data.
20	G2	Green Data.
21	G3	Green Data.
22	GND	Power ground.
23	G4	Green Data.
24	G5	Green Data.
25	G6	Green Data.
26	G7	Green Data.
27	GND	Power ground.
28	B0	Blue Data.
29	B1	Blue Data.



Pin#	Name	DESCRIPTION
30	B2	Blue Data.
31	В3	Blue Data.
32	GND	Power ground.
33	B4	Blue Data.
34	B5	Blue Data.
35	B6	Blue Data.
36	B7	Blue Data.
37	GND	Power ground.
38	HS	Line synchronization signal. Horizontal Sync Input.
39	VS	Frame synchronization signal. Vertical Sync Input.
40	GND	Power ground.
41	DE	Display enable pin from controller. Data Input Enable.
42	GND	Power ground.
43	DCLK	Sample clock. Data will be latched at the falling edge of DCLK.
44	GND	Power ground.
45	CS(NC) / ID1	No Function./ ID[4:1]These pins select LCM type.
46	SDIN(NC) / ID2	No Function./ ID[4:1]These pins select LCM type.
47	SCK(NC) / ID3	No Function ./ ID[4:1]These pins select LCM type.
48	DISPLAY CONTROL / ID4	Display Enable(Hi Active)./ ID[4:1]These pins select LCM type.
49	/RESET	Global Reset (Low Active).
50	GND	Power ground.

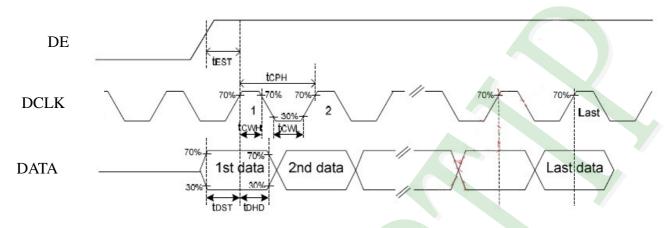
# **Touch Panel Pin Assignment**

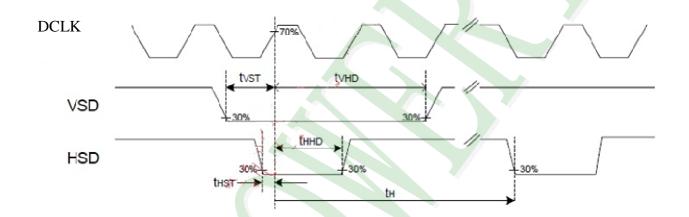
Pin No.	Symbol	Function
1	XR	TP: X right
2	YD	TP: Y bottom
3	XL	TP: X left
4	YU	TP: Y top



## 2.3 Timing Characteristics

## 2.3.1 Input Clock and Data Timing









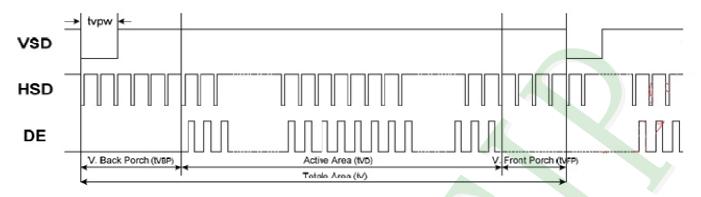
D	0		Spec		1.1.21	0
Parameters	Symbol	Min.	Тур.	Max.	Unit	Conditions
VDD Power ON slew rate	tpor			20	ms	0V ~ 0.9VDD
RSTB pulse width	trst	10			us	CLKIN=50MHz
CLKIN cycle time	tcph	20			ns	
CLKIN pulse duty	tcwн	40	50	60	%	
VSD setup time	tvst	8			ns	
VSD hold time	tvhd	8			ns	
HSD setup time	tHST				ns	
HSD hold time	thhd	8			ns	
Data setup time	tDST	8			ns	D0[7:0], D1[7:0], D2[7:0] to
						CLKIN
Data hold time	tDHD	8			ns	D0[7:0], D1[7:0], D2[7:0] to
						CLKIN
DE setup time	test	8			ns	
DE hold time	tehd	8			ns	
Output stable time	tsst			6	us	10% to 90% target
						voltage.
						CL=120pF, R=10KW
CLKIN frequency	fcLK		40	50	MHZ	VDD=3.0 ~ 3.6V
CLKIN cycle time	fclk	20	25	-	ns	
CLKIN pulse duty	tcwн	40	50	60	%	TCLK
Time from HSD to Source	tHSO		20		CLKIN	
output						
Time from HSD to LD	tHLD	1	20		CLKIN	Note (2)
Time from HSD to STV	tHSTV		2		CLKIN	
Time from HSD to CKV	tHCKV		20		CLKIN	
Time from HSD to OEV	thoev	Î	4		CLKIN	
LD pulse width	twld		10		CLKIN	Note (2)
CKV pulse width	twckv	-	66		CLKIN	
OEV pulse width	twoev		74		CLKIN	

Note: (1) VDD=3.0 ~ 3.6V, VDDA=6.5~13.5V, DGND=AGND=0V, Ta=-20~+85°C

<sup>(2)</sup> The contents of the data register are transferred to the latch circuit at the rising edge of LD. Then the gray scale voltage is output from the device at the falling edge of LD.



## 2.3.2 Vertical input timing



Parameter	Symbol		Ulpit			
Farameter	Symbol	Min	Тур	Max	Unit	
Vertical display area	tvd		480		Н	
VSYNC period time	tv	510	525	650	Н	
VSYNC pulse width	tvpw	1	-	20	Н	
VSYNC ack	tvb	23	23	23	Н	
Porch(Blanking)	ivb	23	23	23	П	
VSYNC Front Proch	tvfb	7	22	147	Н	



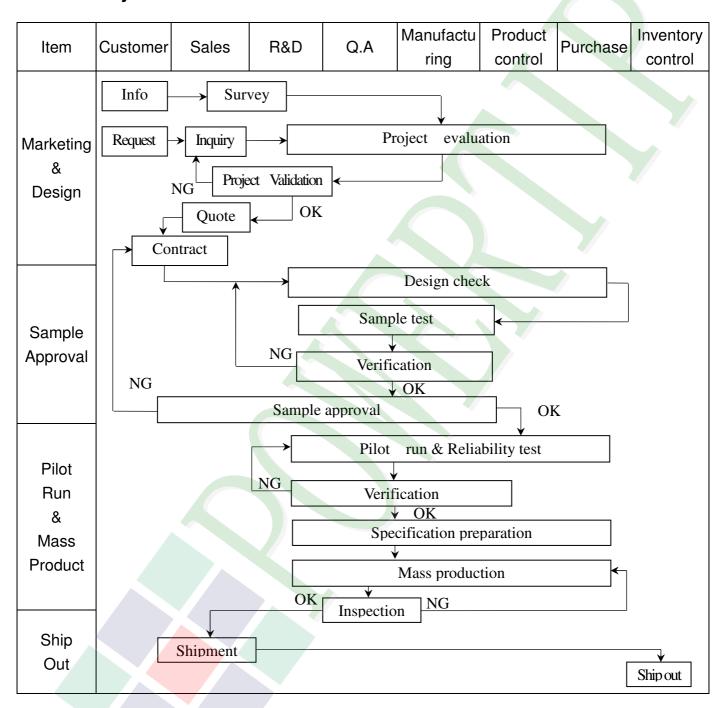


Parameter		Symb		Value		Linit
		ol	Min	Тур	Max	Unit
Horizontal display	y area	thd		800		DCLK
DCLK frequer	псу	fclk	ı	33.3	50	MHz
1 Horizontal L	ine	th	862	862 1056		
	Min	thpw	-	1		
HSD pulse	Тур		-	-		
width	Max	, , , , , , , , , , , , , , , , , , ,	-	40		DCLK
HSD Back Porch (Blacking)		thp	46	46	46	
HSD Front Proch		thfb	16	210	354	

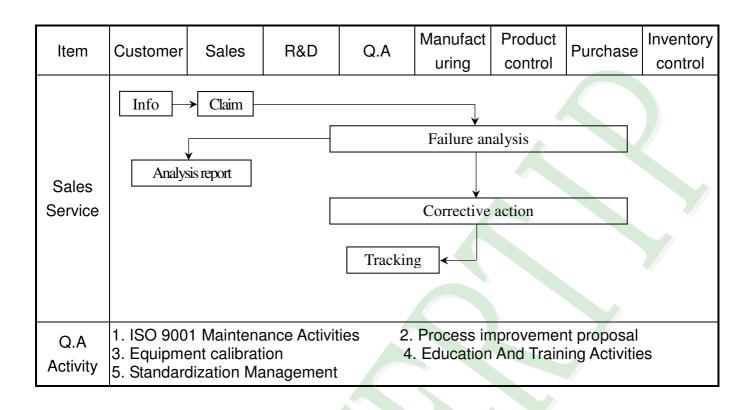


## 3. QUALITY ASSURANCE SYSTEM

## 3.1 Quality Assurance Flow Chart



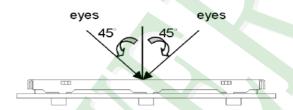




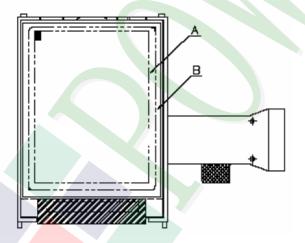


### 3.2 Inspection Specification

- ◆Scope: The document shall be applied to TFT-LCD Module for 3. 5" ~10" (Ver.B01).
- ◆Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.
- ◆Equipment: Gauge · MIL-STD · Powertip Tester · Sample
- ◆Defect Level: Major Defect AQL: 0.4; Minor Defect AQL: 1.5
- **♦**OUT Going Defect Level: Sampling.
- ◆Standard of the product appearance test:
  - a. Manner of appearance test:
  - (1). The test best be under 20W×2 fluorescent light, and distance of view must be at 30 cm.
  - (2). The test direction is base on about around 45° of vertical line.



(3). Definition of area.



A area: viewing area

**B** area: Outside of viewing area

(4). Standard of inspection: (Unit: mm)



◆Specification For TFT-LCD Module 3. 5" ~10":

(Ver.B01)

NO	Item	Criterion	Level			
		1. 1The part number is inconsistent with work order of production.				
01	Product condition	1. 2 Mixed product types.	Major			
		1. 3 Assembled in inverse direction.	Major			
02	Quantity	2. 1The quantity is inconsistent with work order of production.	Major			
03	Outline dimension	3. 1 Product dimension and structure must conform to structure diagram.	Major			
		4. 1 Missing line character and icon.	Major			
		4. 2 No function or no display.	Major			
04	<b>Electrical Testing</b>	4. 3 Display malfunction.				
		4. 4 LCD viewing angle defect.	Major			
		4. 5 Current consumption exceeds product specifications.	Major			
		Item Acceptance (Q'ty)				
	Dot defect	Bright Dot ≤ 4				
	Dot defect	Dot Dark Dot ≤ 5				
	(Bright dot \	Defect Joint Dot ≤ 3				
05	Dark dot)	Total ≤ 7	Minor			
	On -display	5. 1 Inspection pattern: full white, full black, Red, Green and				
		blue screens.  5. 2 It is defined as dot defect if defect area >1/2 dot.				
		5. 3 The distance between two dot defect ≥5 mm.				



## ◆Specification For TFT-LCD Module 3. 5″ ~10″:

(Ver.B01)

NO	Item	Criterion	Level				
		6. 1 Round type ( Non-display or display) :					
		Dimension (diameter : Φ)  Acceptance (Q'ty)  A area  B area					
	Black or white dot > scratch >	$\Phi \le 0.25$ Ignore	<b>\</b>				
	contamination	$0.25 < \Phi \leq 0.50$					
	Round type	$\Phi > 0.50$ Ignore	>				
	$X \longrightarrow X$	Total 5					
06	$\Phi = (x+y)/2$	6. 2 Line type( Non-display or display) :	Minor				
		Length (L) Width (W) Acceptance (Q'ty)					
	Line type	A area B area					
	$\bigcirc$ $\stackrel{\bigstar}{\uparrow}$ W	$W \le 0.03$ Ignore					
	→ı <sub>L</sub>	$L \le 10.0$ $0.03 < W \le 0.05$ 4					
		$L \le 5.0 \qquad 0.05 < W \le 0.10 \qquad 2 \qquad Ignore$					
		W > 0.10					
		Total 5					
		Dimension (diameter : Φ) Acceptance (Q'ty) A area B area					
		$\Phi \le 0.25$ Ignore					
07	Polarizer	$0.25 < \Phi \leq 0.50$	Minor				
	Bubble	$0.50 < \Phi \leq 0.80$ I Ignore					
		$\Phi > 0.80 \qquad \qquad 0$					
		Total 5					



#### ◆Specification For TFT-LCD Module 3. 5″~10″: (Ver.B01)

NO	Item	Criterion				
		Z: The thickness of crack	Y : The width of crack. W : terminal length a : LCD side length			
		8.1 General glass chip: 8.1.1 Chip on panel surface and cra	ack between panels:			
		Z Z	Z Y			
08	The crack of glass	SP Y [OK]	[NG]	Minor		
		Seal width Z	Y			
		X Y	z			
		≤ a Crack can't enter viewing area	≦1/2 <b>t</b>			
		≤ a Crack can't exceed the half of SP width.	$1/2 t < Z \leq 2 t$			



# ◆Specification For TFT-LCD Module 3, 5″ ~10″: (Ver.B01)

NO	•	İ				Level	
NO	Item				Level		
Z: The thickness of crack W					e width of crack. minal length D side length		
		Y X Z					
		X	Y		Z		
		≤1/5 a	Crack can't e viewing ar		$Z \leq 1/2 t$		
		≤1/5 a	Crack can't exc half of SP wi	1//	$t < Z \le 2 t$		
08	08 The crack of glass 8 2 Protrusion over terminal:					Minor	
	The cruck of glass	6.2 Frotrusion over terminar.					
	8.2.1 Chip on electrode pad:						
	W X						
			X	Y	Z		
		Front	≦ a	≤ 1/2 W	<b>≦</b> t		
		Back	$\leq a$	$\leq$ W	$\leq 1/2 t$		



◆Specification For TFT-LCD Module 3. 5" ~10": (Ver.B01)

NO	Itam	Cuitouion	Level		
NO	Item	Criterion			
08	The crack of glass	Symbols:  X: The length of crack Z: The thickness of crack t: The thickness of glass  8. 2. 2 Non-conductive portion:  X  X  X  Y  Z  S  If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications.  8. 2. 3 Glass remain:	Minor		



◆Specification For TFT-LCD Module 3. 5" ~10":

(Ver.B01)

NO	Item	Criterion	Level
09	Backlight elements	9. 1 Backlight can't work normally.	Major
		9. 2 Backlight doesn't light or color is wrong.	Major
		9. 3 Illumination source flickers when lit.	Major
10	General	10. 1 Pin type \quantity \dimension must match type in structure diagram.	Major
		10. 2 No short circuits in components on PCB or FPC.	Major
		10. 3 Parts on PCB or FPC must be the same as on the production characteristic chart . There should be no wrong parts, missing parts or excess parts.	Major
		10. 4 Product packaging must the same as specified on packaging specification sheet.	Minor
		10. 5 The folding and peeled off in polarizer are not acceptable.	Minor
		10. 6 The PCB or FPC between B/L assembled distance(PCB or FPC ) is ≤1.5 mm.	Minor



## 4. RELIABILITY TEST

## 4.1 Reliability Test Condition

(Ver.B01)

4.1	Reliability test Condition (ver.but)					
NO.	TEST ITEM	TEST CONDITION				
1	High Temperature	Keep in +80 ±2°C 96 hrs				
1	Storage Test	Surrounding temperature, then storage at normal condition 4hrs.				
2	2 Low Temperature Keep in -30 ±2°C 96 hrs				/	
	Storage Test	Surrounding temperature, then storage at normal condition 4hrs.				
3	High Temperature /	Keep in +60 ℃ /90% R.H duration for 96 hrs				
	High Humidity	Surrounding temperature, then storage at normal condition 4hrs.				
	Storage Test	(Excluding the polarizer)				
	Temperature Cycling Storage Test	$-30^{\circ}\text{C} \rightarrow +25^{\circ}\text{C} \rightarrow +80^{\circ}\text{C} \rightarrow +25^{\circ}\text{C}$				
4		(30mins) (5mins) (5mins)				
4		10 Cycle				
		Surrounding	g temperature, then sto	rage at normal condition	n 4hrs.	
		Air Dischar	ge:	<b>Contact Discharge:</b>		
		Apply 2 KV	with 5 times	Apply 250 V with 5 tim	nes	
		Discharge for each polarity +/- discharge for each polarity +/-				
	ESD Test	1. Temperature ambiance : 15°C ~35°C				
5		2. Humidity relative : 30 % ∼60 %				
J 3		3. Energy Storage Capacitance(Cs+Cd): 150pF±10%				
		4. Discharge Resistance(Rd): 330Ω±10%				
		5. Discharge, mode of operation :				
		Single Discharge (time between successive discharges at least 1 sec)				
		(Tolerance if the output voltage indication: ±5%)				
	Vibration Test (Packaged)	1. Sine way	ve 10~55 Hz frequency	y (1 min/sweep)		
6		2. The amplitude of vibration :1.5 mm				
		3. Each direction (X \ Y \ Z) duration for 2 Hrs				
	Drop Test (Packaged)		Packing Weight (Kg)	Drop Height (cm)		
			0 ~ 45.4	122		
			45.4 ~ 90.8	76		
7			90.8 ~ 454	61		
			0ver 454	46		
				/0.13		
		Drop Direct	ion :※1 corner / 3 edge	es / 6 sides each ltime		



### 5. PRECAUTION RELATING PRODUCT HANDLING

#### **5.1 SAFETY**

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

#### 5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So, please handle it very carefully, do not touch, push or rub the exposed polarizing with anything harder than an HB pencil lead (glass, tweezers, etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- Do not touch the display area with bare hands, this will stain the display area. 5.2.6
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is 320±10°C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM.

#### **5.3 STORAGE**

- 5.3.1 Store the panel or module in a dark place where the temperature is  $25^{\circ}$ C  $\pm 5^{\circ}$ C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- Do not crush, shake, or jolt the module. 5.3.3

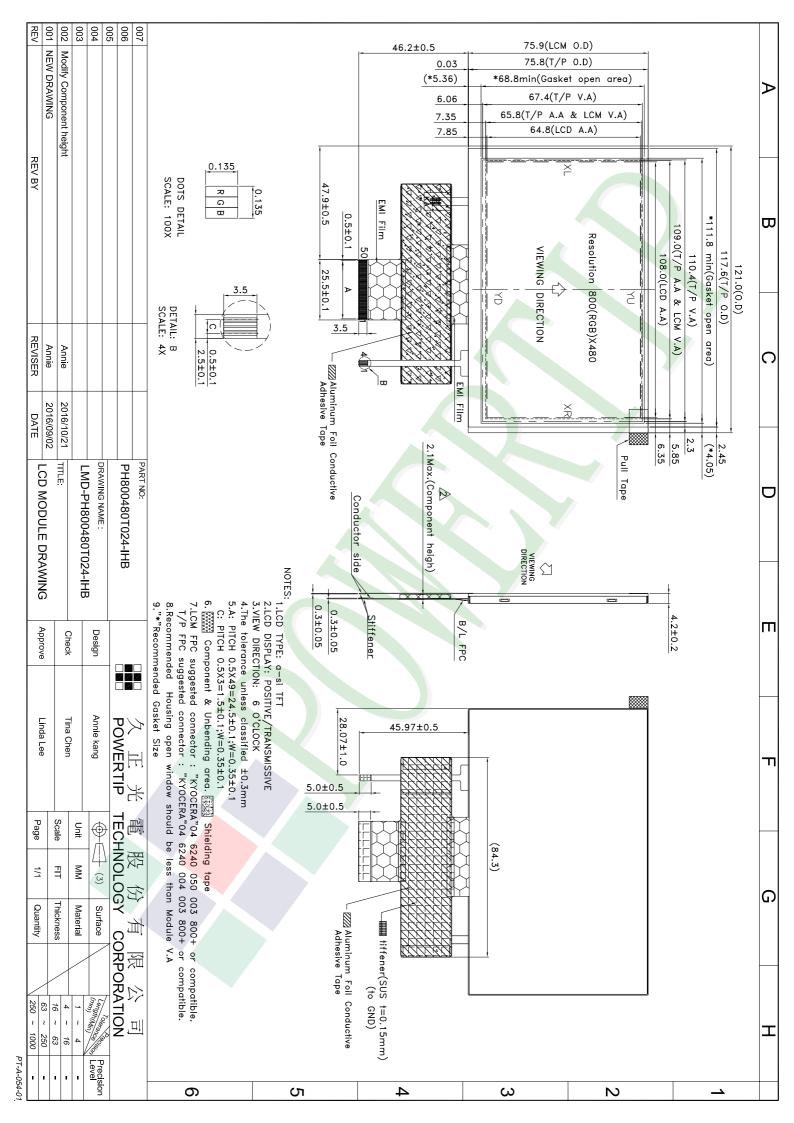
#### **5.4 TERMS OF WARRANTY**

5.4.1 Applicable warrant period

> The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



Approve Check Contact LCM包裝規格書 Ver.001 LCM Packaging Specifications Linda Documents NO. PKG-PH800480T024-IHB Tina Annie (For Tray) 1.包裝材料規格表 (Packaging Material): (per carton) No. Model Dimensions (mm) 1Pcs Weight Quantity Total Weight Item PH800480T024-IHB 121.0 X75.9 1 成品 (LCM) 144 0.0779 11.2176 2 多層薄膜(1)POF OTFILM0BA03ABA 19"X350X0.015 6 3 TRAY 盤 (2)Tray 352 X 260 X 12.8 42 TY00000000308 0.0965 4.053 FOAM000000047 舒美墊(3) EPE 4 350 X 255 X 5 6 0.011 0.066 5 内盒(4)Product Box BX36627063ABBA 383 X 270 X 66 0.182 6 1.092 2 6 保利龍板(5)Polylon board OTPLB00PL08ABA 550 X 393 X 20 0.0284 0.0568 7 外紙箱(6)Carton 570 X 410 X 265 1 BX57041027CCBA 1.0 1.0 8 9 2.一 整箱總重量 (Total LCD Weight in carton ): 17.49 Kg±10% 3.單箱數量規格表 (Packaging Specifications and Quantity): (1)LCM quantity per box : no per tray x no of tray 24 6 (2) Total LCM quantity in carton: quantity per box x no of boxes 24 144 6 (5)保利龍板 Polylon board Use empty tray 空盤 (1)多層薄膜 POF Put products into the tray (2)TRAY 盤 (5)保利龍板 Tray Polylon board (3)EPE (4)内盒 Tray stacking Product Box (6)外紙箱 Carton 記 特 事 項 (REMARK) 斜角 Detail B 圓角 4.TRAY盤相疊時,需旋轉180度,請詳見B視圖 Rotate tray 180 degrees and place on top of stack. Check the tray stack using Fig. B.